



# CPC1983B Single-Pole, Normally Open OptoMOS<sup>®</sup> Power SOIC Relay

Parameter	Rating	Units
Blocking Voltage	600	V <sub>P</sub>
Load Current	0.5	A <sub>DC</sub> / A <sub>rms</sub>
On-Resistance (max)	6	Ω

# **Features**

- 12.5mm of Creepage (with Appropriate Layout)
- Continuous Load Currents Up to 0.5A
- 600V<sub>P</sub> Blocking Voltage
- 5000V<sub>rms</sub> Input/Output Isolation
- Power SOIC Package
- High Reliability
- Low Drive Power Requirements
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Flammability Rating UL 94 V-0

# **Applications**

- Industrial Controls
- Motor Control
- Robotics
- Medical Equipment—Patient/Equipment Isolation
- Instrumentation
- Multiplexers
- Data Acquisition
- · Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- IC Equipment
- Home Appliances

### Description

IXYS Integrated Circuits brings OptoMOS technology, reliability, and compact size to a new family of high power Solid State Relays.

As part of this family, the CPC1983B single-pole, normally open (1-Form-A) Solid State Power Relay is rated for up to 0.5  $A_{DC}$  /  $A_{rms}$  continuous load current.

The CPC1983B employs optically coupled MOSFET technology to provide  $5000V_{rms}$  of input to output isolation. The optically coupled outputs, that use patented OptoMOS architecture, are controlled by a highly efficient infrared LED.

This combination of low on-resistance and high load current handling capability makes this relay suitable for a variety of high performance switching applications.

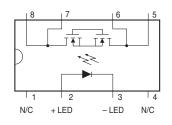
# **Approvals**

• UL 508 Recognized Component: File E69938

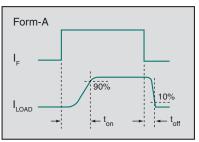
# **Ordering Information**

Part #	Description
CPC1983B	Power SOIC Package (25 per tube)

# **Pin Configuration**



#### Switching Characteristics of Normally Open Devices







# Absolute Maximum Ratings @ 25°C

-	
Ratings	Units
600	V <sub>P</sub>
5	V
50	mA
1	A
150	mW
2400	mW
5000	V <sub>rms</sub>
8	kV
-40 to +85	°C
-40 to +125	°C
	600 5 50 1 150 2400 5000 8 -40 to +85

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

Derate linearly 3.33 mW / °C
Derate linearly 20 mW / °C

# Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Тур	Max	Units	
Output Characteristics		11		1			
Load Current, Continuous	I <sub>F</sub> =5mA, Free air	١	-	-	0.5	A <sub>DC</sub> / A <sub>rms</sub>	
Peak Load Current	I <sub>F</sub> =5mA, t≤10ms	I <sub>LPK</sub>	-	-	±3	A	
On-Resistance <sup>1</sup>	I <sub>F</sub> =5mA, I <sub>L</sub> =0.5A	R <sub>ON</sub>	-	3.5	6	Ω	
Off-State Leakage Current	I <sub>F</sub> =0mA, V <sub>I</sub> =600V <sub>P</sub>	ILEAK	-	-	1	μΑ	
Switching Speeds							
Turn-On		t <sub>on</sub>	-	2.2	5	22.0	
Turn-Off	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>off</sub>	-	0.15	2	ms	
Output Capacitance	I <sub>F</sub> =0mA, V <sub>I</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	41	-	pF	
Input Characteristics	<u>_</u>						
Input Control Current to Activate	I <sub>1</sub> =0.5A	l <sub>F</sub>	-	1.3	5	mA	
Input Control Current to Deactivate	-	l <sub>F</sub>	0.5	-	-	mA	
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.5	V	
Reverse Input Current	V <sub>R</sub> =5V	I <sub>B</sub>	-	-	10	μΑ	
Input/Output Characteristics							
Capacitance, Input to Output	V <sub>IO</sub> =0V, f=1MHz	CIO	-	2	-	pF	

<sup>1</sup> Measurement taken within 1 second of on-time.

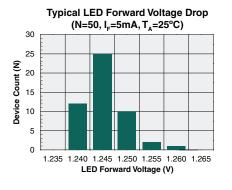
# **Thermal Characteristics**

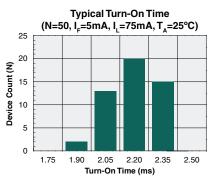
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Thermal Impedance (junction to case)	-	R <sub>ejc</sub>	-	1.5	-	°C/W

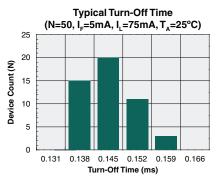


# CPC1983B

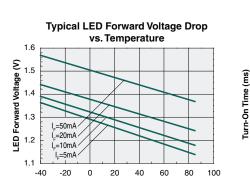
# **PERFORMANCE DATA\***



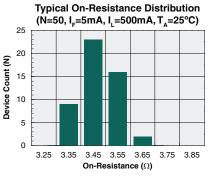




Typical I<sub>2</sub> for Switch Operation (N=50, I<sub>L</sub>=500mA, T<sub>A</sub>=25°C) 25 20 Device Count (N) 15 10 5 0 1.0 1.5 1.2 1.3 1.4 1.1 LED Forward Current (mA)



Temperature (°C)



**Typical Turn-On Time** 

vs. LED Forward Current

(I, =75mA, T, =25°C)

6

5

4

3

2

1

0

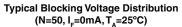
0

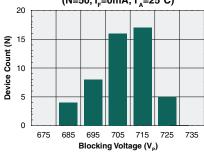
10

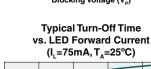
20

30

LED Current (mA)



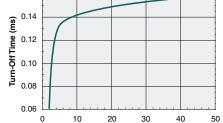




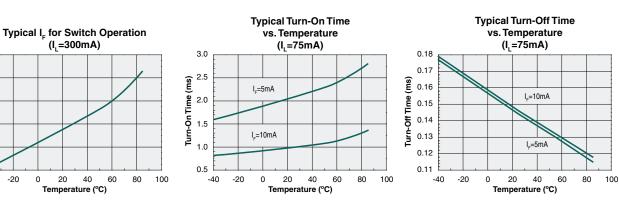
0.16

50

40



LED Current (mA)



\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

1.8

1.6

1.4

1.2

1.0

0.8

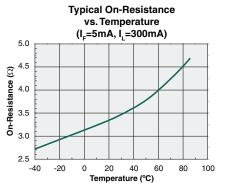
-40

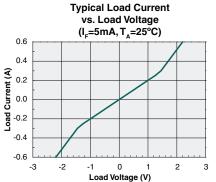
LED Current (mA)

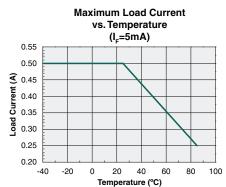


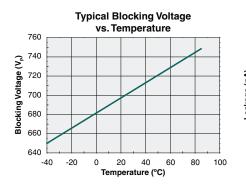
# CPC1983B

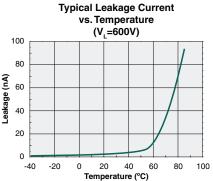
### **PERFORMANCE DATA\***

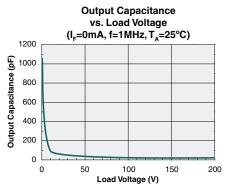


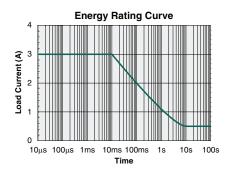












\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.



# **Manufacturing Information**

#### **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification		
CPC1983B	MSL 1		

#### **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

### **Soldering Profile**

Provided in the table below is the Classification Temperature  $(T_C)$  of this product and the maximum dwell time the body temperature of this device may be  $(T_C - 5)^{\circ}C$  or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature $(T_c)$	Dwell Time (t <sub>p</sub> )	Max Reflow Cycles
CPC1983B	245°C	30 seconds	3

#### **Board Wash**

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



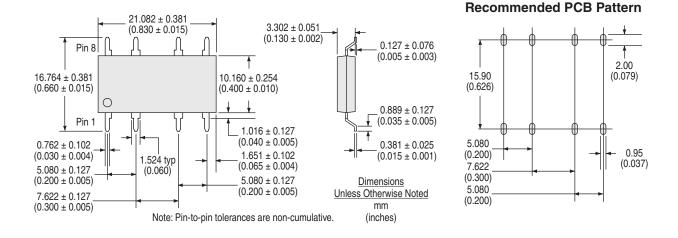
5



# CPC1983B

# **MECHANICAL DIMENSIONS**

### **CPC1983B**



#### For additional information please visit our website at: www.ixysic.com

IXYS Integrated Circuits makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits' Standard Terms and Conditions of Sale, IXYS Integrated Circuits assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits' product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits reserves the right to discontinue or make changes to its products at any time without notice.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

IXYS: CPC1983B